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(71) Applicant (for all designated States except US): **KONIN-
KLIJKE PHILIPS ELECTRONICS N.V.** [NL/NL];
Groenewoudseweg 1, NL-5621 BA Eindhoven (NL).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **KURT, Ralph**
[DE/NL]; c/o Prof. Holstlaan 6, NL-5656 AA Eindhoven
(NL). **DE KOK-VAN BREEMEN, Margaretha, M.**
[NL/NL]; c/o Prof. Holstlaan 6, NL-5656 AA Eindhoven
(NL). **BECHTEL, Hans-Helmut** [DE/DE]; c/o Prof.
Holstlaan 6, NL-5656 AA Eindhoven (NL). **SETAYESH,**

Sepas [IR/NL]; c/o Prof. Holstlaan 6, NL-5656 AA
Eindhoven (NL). **BROER, Dirk, J.** [NL/NL]; c/o Prof.
Holstlaan 6, NL-5656 AA Eindhoven (NL). **JAK, Martin,
J., J.** [NL/NL]; c/o Prof. Holstlaan 6, NL-5656 AA
Eindhoven (NL).

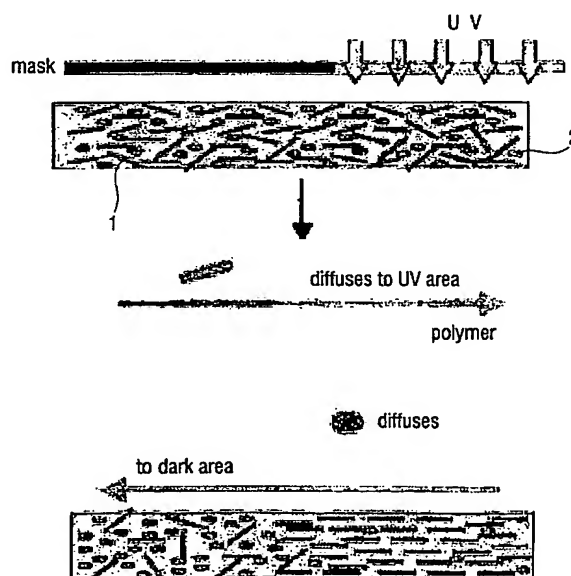
(74) Agents: **ROLFES, Johannes, G., A.** et al.; Prof. Holst-
laan 6, NL-5656 AA Eindhoven (NL).

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(54) Title: METHOD FOR PHOTO-EMBOSSING A MONOMER-CONTAINING LAYER



(57) Abstract: The invention relates to a method for photo-embossing a monomer-containing layer for obtaining a photovoltaic cell, a light emitting diode (LED), or a light emitting electrochemical cell (LEC) by the steps of: (a) optionally providing one or more layers onto the surface of the monomer-containing layer; (b) irradiating through a mask a layer consisting of a homogeneous blend of at least two different compounds, at least one of which is a polymerizable monomer, to obtain a monomer-containing layer with exposed and non-exposed areas; (c) optionally providing further layers onto the surface of the monomer-containing layer; (d) expanding the exposed or the non-exposed areas by diffusing at least one of the monomers to the exposed areas to obtain a corrugated surface of the layer; or interchanging steps c) and d).



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